T363 & T369 MIL-PRF-49137/2 (CX02 & CX12 Style)



Overview

KEMET's T363 and T369 series of radial dipped capacitors are manufactured to fulfill the requirements of MIL-PRF-49137 style CX02 and CX12, while maintaining all performance characteristics of the UltraDip II capacitors. In addition to the standard UltraDip II process testing, all products supplied to MIL-PRF-49137 are sampled on a lot-by-lot basis for Group A and Group B inspection to

ensure compliance and also receives an additional postprocess burn-in for at least two hours under accelerated voltage stress in excess of 125% of DC rated voltage. This post-process burn-in is equivalent to 200 hours under rated conditions.

Benefits

- Tape & Reel packaging per EIA Specification RS-468
- · Laser-marked case
- Qualified to MIL-PRF-49137
- Capacitance values of 0.1 330 μF
- Tolerances of ±10% and ±20%
- Voltage rating of 6 50 VDC
- T363 case sizes: A, B, C, D
- · T369 case sizes: A, B

Applications

Typical applications include filtering, bypassing, coupling, blocking, and RC timing circuits, or other applications that can benefit from compactness.

T363



T369





Ordering Information

Т	36X	Α	105	М	035	Α	S	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Failure Rate	Termination Finish	Packaging
T = Tantalum	363 369	A, B, C, D	First two digits represent significant figures. Third digit specifies number of zeros to follow.	M = ±20% K = ±10%	006 = 6 010 = 10 015 = 15 020 = 20 025 = 25 035 = 35 050 = 50	Not Applicable	S = Standard	Blank = Bulk 7301 = Tape & Reel 7303 = Tape & Reel 7305 = Ammo 7317 = Ammo

Ordering Information - Defense MIL-PRF-49137/2 (CX02 and CX12 Style)

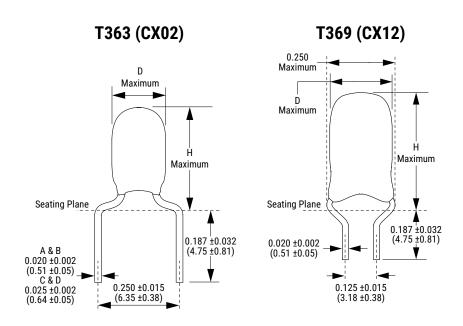
СХ	J	225	K
Style	Voltage	Capacitance Code (pF)	Capacitance Tolerance
CX = Capacitors, Fixed, Solid Electrolyte, Tantalum,Polar, Conformal Coated, Nonhermetically Sealed. 02 /12 = Style	D = 6 V F = 10 V H = 15 V J = 20 V K = 25 V M = 35 V N = 50 V	First two digits represent significant figures. Third digit specifies number of zeros to follow.	M = ±20% K = ±10%



Performance Characteristics

Item	Performance Characteristics
Operating Temperature	-55°C to 125°C
Rated Capacitance Range	0.1 – 330 μF at 120 Hz/25°C
Capacitance Tolerance	M tolerance ±20%, K tolerance ±10%
Rated Voltage Range	6 – 50 V
DF (120 Hz at 25°C)	Refer to Part Number Electrical Specification Table
Leakage Current	Refer to Part Number Electrical Specification Table (rated voltage up to 85°C)

Dimensions - Inches (Millimeters)



KEMET Case Size	Style	MIL Case Size	D Maximum Diameter	H Maximum Height	Lead Size Diameter
Α		Α	0.175 (4.45)	0.425 (10.80)	0.020
В	CX02	В	0.250 (6.35)	0.500 (12.70)	0.020
С		С	0.350 (8.89)	0.650 (16.51)	0.025
D		D	0.400 (10.16)	0.750 (19.05)	0.025
А	0.740	Е	0.175 (4.45)	0.350 (8.89)	0.020
В	CX12	F	0.250 (6.35)	0.500 (12.70)	0.020



Table 1 - Ratings and Part Number Reference

Rated	Rated	Case Code	KEMET	DC	DF % at	Military Pa Per MIL-PF	
Voltage	Capacitance	Case Size	Part Number	Leakage	25°C	CX02 (T363)	CX12 (T369)
(V) 85°C	μF			μΑ at 25°C Maximum/5 Minutes	120 Hz Maximum		
6	6.8	Α	T36(1)A685(2)006AS	0.5	6.0	CX02D685(2)	CX12D685(2)
6	47.0	В	T36(1)B476(2)006AS	2.3	6.0	CX02D476(2)	CX12D476(2)
6	68.0	В	T36(1)B686(2)006AS	3.3	6.0	CX02D686(2)	CX12D686(2)
6	150.0	С	T363C157(2)006AS	7.2	8.0	CX02D157(2)	
6	330.0	D	T363D337(2)006AS	10.0	8.0	CX02D337(2)	
10	4.7	Α	T36(1)A475(2)010AS	0.5	5.0	CX02F475(2)	CX12F475(2)
10	33.0	В	T36(1)B336(2)010AS	2.6	6.0	CX02F336(2)	CX12F336(2)
10	100.0	С	T363C107(2)010AS	8.0	8.0	CX02F107(2)	
10	220.0	D	T363D227(2)010AS	10.0	8.0	CX02F227(2)	
15	3.3	Α	T36(1)A335(2)015AS	0.5	5.0	CX02H335(2)	CX12H335(2)
15	22.0	В	T36(1)B226(2)015AS	2.6	6.0	CX02H226(2)	CX12H226(2)
15	68.0	С	T363C686(2)015AS	8.2	6.0	CX02H686(2)	
15	150.0	D	T363D157(2)015AS	10.0	8.0	CX02H157(2)	
20	2.2	Α	T36(1)A225(2)020AS	0.5	5.0	CX02J225(2)	CX12J225(2)
20	15.0	В	T36(1)B156(2)020AS	2.4	6.0	CX02J156(2)	CX12J156(2)
20	47.0	С	T363C476(2)020AS	7.5	6.0	CX02J476(2)	
20	100.0	D	T363D107(2)020AS	10.0	8.0	CX02J107(2)	
25	1.5	Α	T36(1)A155(2)025AS	0.5	5.0	CX02K155(2)	CX12K155(2)
25	10.0	В	T36(1)B106(2)025AS	2.0	6.0	CX02K106(2)	CX12K106(2)
25	33.0	С	T363C336(2)025AS	6.6	6.0	CX02K336(2)	
25	68.0	D	T363D686(2)025AS	10.0	6.0	CX02K686(2)	
35	6.8	В	T36(1)B685(2)035AS	1.9	5.0	CX02M685(2)	CX12M685(2)
35	22.0	С	T363C226(2)035AS	6.2	6.0	CX02M226(2)	
35	33.0	D	T363D336(2)035AS	9.2	6.0	CX02M336(2)	
35	47.0	D	T363D476(2)035AS	10.0	6.0	CX02M476(2)	
50	0.1	Α	T36(1)A104(2)050AS	0.5	3.0	CX02N104(2)	CX12N104(2)
50	0.15	Α	T36(1)A154(2)050AS	0.5	3.0	CX02N154(2)	CX12N154(2)
50	0.22	Α	T36(1)A224(2)050AS	0.5	3.0	CX02N224(2)	CX12N224(2)
50	0.33	A	T36(1)A334(2)050AS	0.5	3.0	CX02N334(2)	CX12N334(2)
50	0.47	A	T36(1)A474(2)050AS	0.5	3.0	CX02N474(2)	CX12N474(2)
50	0.68	A	T36(1)A684(2)050AS	0.5	3.0	CX02N684(2)	CX12N684(2)
50	1.0	A	T36(1)A105(2)050AS	0.5	3.0	CX02N105(2)	CX12N105(2)
50	1.5	В	T36(1)B155(2)050AS	0.6	5.0	CX02N155(2)	CX12N155(2)
50	2.2	В	T36(1)B225(2)050AS	0.9	5.0	CX02N225(2)	CX12N225(2)
50	3.3	В	T36(1)B335(2)050AS	1.3	5.0	CX02N335(2)	CX12N335(2)
50	4.7	В	T36(1)B475(2)050AS	1.9	5.0	CX02N475(2)	CX12N475(2)
50	6.8	C	T363B685(2)050AS	2.7	5.0	CX02N685(2)	
50	10.0	C C	T363C106(2)050AS	4.0	6.0	CX02N106(2)	
50 50	15.0 22.0	D	T363C156(2)050AS	6.0 8.8	6.0 6.0	CX02N156(2)	
		ט	T363D226(2)050AS uA at 25°C		0.0 Ω at25°C	CX02N226(2) CX02	CX12
(V) 85°C	μF	Case	µA at 25°С Maximum/5 Minutes	120 Hz Maximum	100 kHz Max	(T363)	(T369)
Rated Voltage	Rated Capacitance	Size Code	DC Leakage	DF % at 25°C	ESR	Military Part Number Per MIL-PRF-49137/2	

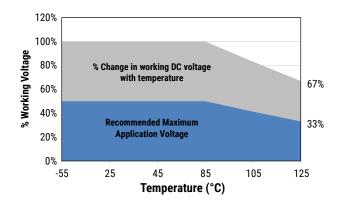
⁽¹⁾ To complete KEMET Part Number, insert Series Designation as follows: "3" - T363 (CX02); "9" - T369 (CX12)

⁽²⁾ To complete KEMET or military part number, insert M - 20%, K - ±10%. Designates Capacitance tolerance.



Recommended Voltage Derating Guidelines

	-55°C to 85°C	85°C to 125°C
% Change in working DC voltage with temperature	V _R	66% of V _R
Recommended Maximum Application Voltage	50% of V _R	33% of V _R



Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage that may be applied is limited by following criteria:

- 1. Dissipated power must not exceed the limits specified for the Series.
- 2. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
- 3. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage.

Thermal capacities for the various case sizes have been determined empirically and are listed below. The "ripple voltage" permissible may be calculated from the impedance and ESR data shown in the respective product section.

Temperature Compensation Multipliers for Maximum Power Dissipation						
T ≤ 25°C	T ≤ 25°C T ≤ 85°C T ≤ 125°C					
1.00 0.90 0.40						

T= Environmental Temperature

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

Case Size	Maximum Power Dissipation (Pmax) Watts at 25°C
Α	0.050
В	0.075
С	0.090
D	0.135

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

 $I(max) = \sqrt{P max/R}$ $E(max) = Z \sqrt{P max/R}$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

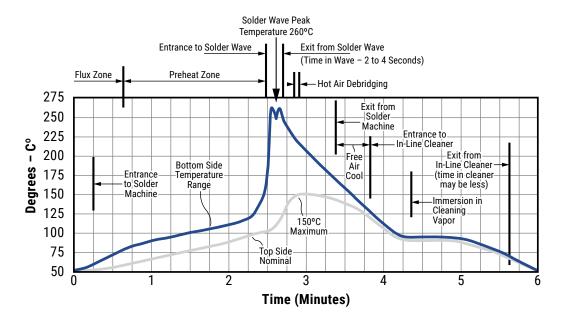
P max = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)Soldering Process



Optimum Solder Wave Profile



Reverse Voltage

Although these are polar capacitors, some degree of transient voltage reversal is permissible, as seen below. The capacitors should not be operated continuously in reverse mode, even within these limits.

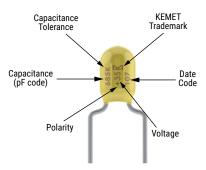
Temperature	Pecentage of Rated Voltage
+25°C	15
+85°C	5
+125°C	1

Mounting

All encased capacitors will pass the Resistance to Soldering Heat Test of MIL-STD-202, Method 210, Condition C. This test simulates wave solder of topside board mount product. This demonstration of resistance to solder heat is in accordance with what is believed to be the industry standard. More severe treatment must be considered reflective of an improper soldering process. The above figure is a recommended solder wave profile for both axial and radial leaded solid tantalum capacitors. Table 2 – Performance & Reliability: Test Methods and Conditions



Capacitor Marking



Storage

Tantalum molded radial/axial capacitors should be stored in normal working environments. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60°C RH. Storage at high temperature may cause a small, temporary increase in leakage current (measured under standard conditions), but the original value is usually restored within a few minutes after application of rated voltage. Storage at high humidity may increase capacitance and dissipation factor. Solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. For optimized solderability capacitors stock should be used promptly, preferably within three years of receipt.

Tape & Reel Packaging Information

Table 2 - Packaging Quantity

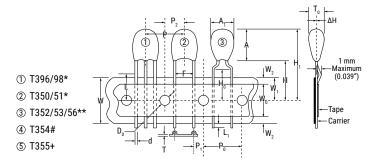
Case Size	Standard Bulk Quantity	Standard Reel Quantity	Reel C-Spec	Ammo Pack Quantity
Α	1,000	1,500		2,500
В	1,000	1,500	C-7301/7303	2,000
С	500	500		800
D	500	500	Pending	800

T363 A - D cases.

T369 A and B cases only.



Figure 1



Dimension	Symbol		Nominal mm (inch)		ance nch)	
Body Height (1)	Α	17.0 (0.67)	Maximum		
Body Width (1)	A ₁	15.24 (0.600)	Maxir	Maximum	
Sprocket Hole Diameter	D ₀	4.0 (0	.157)	±0.3 (±	0.012)	
Lead Diameter	d	0.51 (0.020)	0.64 (0.025)	±0.05 (±	0.002)	
Lead Center (4)	F		See Not	e Below		
Component Base to Tape Center (4)	Н	C-7301 16.0 (0.630)	C-7303 18.0 (0.709)	C-7301 ±0.5 (±0.02)	C-7303 Minimum	
Lead Standoff Height	Lead Standoff Height H_0		C-7303 18.0 (0.709)	C-7301 ±0.5 (±0.02)	C-7303 Minimum	
Component Height Above Tape Center	Tape Center H ₁ 32.25 (1.270)		Maximum			
Component Alignment Front to Rear	ΔΗ	()	1.0 (0.039)		
Cut Out Length	L	11.0 (0	0.433)	Maximum		
Lead Protrusion	L ₁	1.0 (0	.039)	Maxir	num	
Component Pitch (5)	Р	12.7 (0	0.500)	±1.0 (±0	0.039)	
Sprocket Hole Pitch (2)	P ₀	12.7 (0	0.500)	±0.03 (±	0.012)	
Sprocket Hole Center to Lead Center (3) (4)	P ₁	See Not	e Below	±0.7 (±0.028)		
Sprocket Hole Center to Component Center (5)	P ₂		See Not	e Below		
Body Thickness	Body Thickness T_0 10.2 (0.400)		0.400)	Maximum		
Total Tape Thickness	Т	T 0.7 (0.28)		±0.02 (±0.008)		
Carrier Tape Width	W	18.0 (0.709)		+1.0/-0.5 (+0.	039/-0.020)	
Hold-Down Tape Width	W _o	15 mm (0.561) 6 mm (0.236)		+1.0/-0.8 (+0	.039/-0.031	
Sprocket Hole Location	W ₁	9.0 (0.354)		+0.075/-0.5 (+0.030/-0.020)		
Hold-Down Tape Location	W ₂	12.0 (0.472)		Maximum		

Notes:

- (1) See Dimensions table for specific values per case size.
- (2) Cumulative pitch error ±1.0 mm (0.039) maximum in 20
- * Lea
- ** Le # Lea
- + Lea

consecutive sprocket hole locations. (3) Measured at bottom of standoff.	0.100" ±0.015	Lead Spacing
(4) P_1 and F measured at egress from carrier tape.	0.125" ±0.015	0.100" - 0.200 ±0.028"
(5) P and P2 measured at egress from carrier tape.	0.200" ±0.015	0.125" - 0.187 ±0.028"
ead spacings are 2.5 mm (0.098") center to center (T350 A-H) Lead spacings are 5.0 mm (0.197") center to center	0.250" ±0.015"	0.200" - 0.150 ±0.028"
ead spacings are 6.35 mm (0.25") center to center	0.100" ±0.015 (3 leaded)	0.250" - 0.125 ±0.028"
ead spacings are 3.18 mm (0.125") center to center		0.100" - 0.100 ±0.028" (3 leaded)

F Dimensions:

P₁ Dimensions:



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